10-24-04 **ESS MAILING UNDER 37 CFR 1.10** I hereby certify that on the date indicated below, this paper was eposited with the U.S. Postal Service and that it was addressed for PLEASE CHARGE ANY DEFICIENCY UP TO \$300.00 OR CREDIT ANY delivery to the Commissioner for Patents, P.O. Box 1450, Alexandria, EXCESS IN THE FEES DUE WITH THIS DOCUMENT TO OUR VA 22313-1450 by "Express Mail Post Office to Addressee" service. **DEPOSIT ACCOUNT NO. 04-0100** Date Name Signature Customer No.: Docket No.: 09864/0202607-US0 07278 IN THE UNITED STATES PATENT AND TRADEMARK OFFICE In re Application of: Takashi Nakai et. al. Serial No.: 10/531,813 Filed: April 18, 2005 For: METHOD FOR FORMING COMPACT FROM POWDER AND MOLD APPARATUS FOR POWDER MOLDING REQUEST FOR CORRECTED FILING RECEIPT I hereby certify that, on the date indicated above, this paper or fee was deposited with the U.S. Postal Service & that it was addressed for delivery to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313 1450 by Express Mail Commissioner of Patents and Trademarks P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Attached is a copy of the official filing receipt received from the PTO in the above applica-1. tion for which issuance of a corrected filing receipt is respectfully requested.

There is an error with respect to the following data, which is: 2.  $\boxtimes$ incorrectly entered and/or omitted.

Error in		Correct data					
	Applicant's name						
$\boxtimes$	Applicant's address	Takashi Nakai, <b>Niigata-shi,</b> Japan Kinya Kawase, <b>Niigata-shi,</b> Japan					
$\boxtimes$	Title	METHOD FOR FORMING COMPACT FROM POWDER AND MOLD APPARATUS FOR POWDER MOLDING					
	Filing Date						
	Application Number						
	Foreign/PCT Application Re:						
	Other						
Remarks:							
	Enclosed please find a copy of the Application Data Sheet.						
The Commissioner is respectfully requested to issue a new and correct Filing Receipt.							
		Respectfully submitted,					
Dated: October 20, 2005		<b>3</b> /					
		Flynn Barrison Reg. No. 53,970 Agent for Applicant(s)					
	Y & DARBY P.C. ox 5257						
	ork, New York 10150-5257						

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UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Viginia 22313-1450 www.uspto.gov

APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/531,813	04/18/2005	1775	900	09864/0202607-US0	3	18	1

**CONFIRMATION NO. 3685** 

FILING RECEIPT

\*OC000000017149162\*

7278 DARBY & DARBY P.C. P. O. BOX 5257 NEW YORK, NY 10150-5257

Date Mailed: 10/06/2005

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Takashi Nakai, Niigata, JAPAN; Kinya Kawase, Niigata, JAPAN;

### **Assignment For Published Patent Application**

Mitsubishi Materials Corporation, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 7278.

## Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/14643 11/18/2003

### Foreign Applications

JAPAN 2002-338621 11/21/2002

Projected Publication Date: To Be Determined - pending completion of Security Review

Non-Publication Request: No

Early Publication Request: No

**Title** 

Letter Poreign Plg. Method for forming compact from powder and mold apparatus for powder forming

**Preliminary Class** 

428

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# **Application Information**

Application Type:: Regular

Subject Matter:: Utility

Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None

Sequence submission?:: None

Computer Readable Form (CRF)?:: No

Title:: METHOD FOR FORMING COMPACT

FROM POWDER AND MOLD APPARATUS

FOR POWDER MOLDING (AS AMENDED)

Attorney Docket Number:: 09864/0202607-US0

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure:: Fig. 1

Total Drawing Sheets:: 3

Small Entity?::

Petition included?:: No

Secrecy Order in Parent Appl.?:: No

# **Applicant Information**

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Takashi

Family Name:: Nakai

City of Residence:: Niigata-shi

Country of Residence:: Japan

Street of mailing address:: c/o Mitsubishi Materials Corporation Niigata

Plant

1-1, Koganecho 3-chome

City of mailing address::

Niigata-shi

State or Province of mailing address::

Niigata

Country of mailing address::

Japan

Postal or Zip Code of mailing address::

950-8640

**Applicant Authority Type::** 

Inventor

Primary Citizenship Country::

Japan

Status::

Full Capacity

Given Name::

Kinya

Family Name::

Kawase

City of Residence::

Niigata-shi

Country of Residence::

Japan

Street of mailing address::

c/o Mitsubishi Materials Corporation Niigata

Plant

1-1, Kogane-cho 3-chome

City of mailing address::

Niigata-shi

State or Province of mailing address::

Niigata

Country of mailing address::

Japan

Postal or Zip Code of mailing address::

950-8640

# **Correspondence Information**

Correspondence Customer Number::

07278

## **Representative Information**

Representative Customer Number::

07278

# **Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2003/014643	11/18/03

# **Foreign Priority Information**

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-338621	11/21/02	No

# **Assignee Information**

Assignee name::

Mitsubishi Materials Corporation

Street of mailing address::

5-1, Ohtemachi 1-chome

Chiyoda-ku,

City of mailing address::

Tokyo

Country of mailing address::

Japan